

Appl. No. 10/525,996
Amdt. dated September 11, 2007
Reply to Office Action of May 17, 2007
Attorney Docket No. 1217-050618

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Appl. No.	:	10/525,996	Confirmation No. 6221
Applicants	:	Hideo SENOO et al.	
Filed	:	February 28, 2005	
Title	:	Semiconductor Wafer Protection Structure and Laminated Protective Sheet for Use Therein	
Art Unit	:	2811	
Examiner	:	Cuong Q. Nguyen	
Customer No.	:	28289	

MAIL STOP AF
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

RESPONSE

Sir:

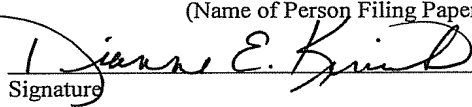
In response to the Final Office Action dated May 17, 2007, Applicants submit the following remarks. Applicants also submit herewith a Petition for a One-Month Extension of Time, extending the deadline for reply until September 17, 2007. The present Amendment is deemed timely filed.

Remarks begin on page 2 of this paper.

I hereby certify that this correspondence is being electronically filed via EFS WEB to the Commissioner for Patents at the United States Patent and Trademark Office on September 11, 2007.

Dianne E. Kimak

(Name of Person Filing Paper)


Signature

09/11/2007

Date